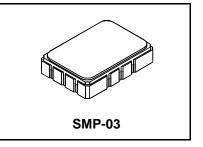
- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- Complies with Directive 2002/95/EC (RoHS)

# SF1146B

### 499.25 MHz SAW Filter



#### Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	emperature Range -40 to +85 °C	
Suitable for lead-free soldering - Max Soldering Profile	260°C	for 30 s

#### **Electrical Characteristics**

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency		f <sub>C</sub>	1		499.25		MHz
Passband Insertion Los	ss at fc	IL				3.5	dB
1.5 dB Pas	ssband	BW <sub>1</sub>		±15			kHz
4.0 dB Pas	ssband		1, 2	30			MHz
Group Delay Variation over fc ±2	50 kHz	GDV			177	250	ns <sub>P-P</sub>
Rejection fc±1.	.5 MHz		1, 2, 3	5			
fc±6.	.0 MHz		1, 2, 3	20			dB
fc±5	50 MHz			50			
Operating Temperature Range		Τ <sub>Α</sub>	1	-40		+85	°C
Differential Input and Output Impedance after matching				5	0 ohms		
Case Style			6	SMF	P-03 7 x 5 mm	Nominal Foot	orint
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			0		RFM SF1146	B YYWWS	

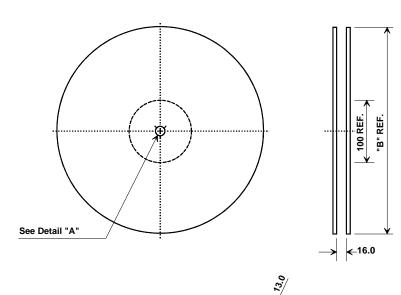
#### **Electrical Connections**

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others

#### Notes:

- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- 3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- 6. Tape and Reel Standard ANSI / EIA 481.
- 7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 8. US and international patents may apply.
- 9. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
- 10. ©Copyright 1999, RF Monolithics Inc.
- Electrostatic Sensitive Device. Observe precautions for handling

### **Tape and Reel Specifications**



"B " Nominal Size		Quantity Per Reel		
Inches	millimeters			
7	178	500		
13	330	2000		

#### **COMPONENT ORIENTATION and DIMENSIONS**

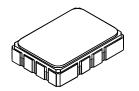
2.0 70,-

	Carrier Tape Dimensions	
	Ао	5.5 mm
	Во	7.5 mm
COVER TAPE SIZE	Ко	2.0 mm
	Pitch	8.0 mm
	w	16.0 mm
COVER TAPE (CARRIER TAPE	SIZE) N #1 A0 USER DIRECTION OF FEE	P (PITCH)

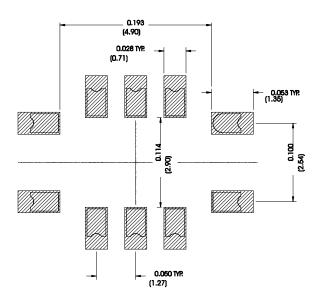
### SAW Filter

## SMP-03 Case

### 10-Terminal Ceramic Surface-Mount Case 7 x 5 mm Nominal Footprint



**Recommended PCB Footprint** 



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D		0.60			0.024	
E		2.54			0.100	
Н		1.0			0.039	
J		5.00			0.197	
K		3.00			0.118	
Р		1.27			0.050	

Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	10		
	Return or Input	1		
Port 2	Output or Return	5		
	Return or Output	6		
Ground		All others		
Single Ended Operation		Return is ground		
Differential Operation		Return is hot		

Materials			
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80- 200 ulnches (203-508 uM) Ni.		
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
Pb Free			

